

Multilayer Ceramic Chip Capacitor

Part Number:	2220YA250103	KETB16	LINGCRINTION	2220 250Vac 50/60Hz 10nF ±10% X7R (2R1) to AEC-Q200	
Approval	IEC/EN60384-14:2013+A	1		>	
Specifications:	UL-60384-14:2014				
	CAN/CSA E60384-14:2014		<	T	
Certification:	TÜV R60150396 / ID1111226226			Ť	
	UL/cUL E228790-20120110			+ 2	
			<		
Classification:	TÜV Y2 / X1 (Type A)			the LA	
				L2-	
	UL/cUL FOWX2, FOWX8	(Type A)			
			Component I	Marking and Certification Bodies:	
Material Group I	· CTI >= 600		S A 4n7		
Material Group I : CTI >= 600 Mechanical Specification					
Size Code		Meenamea	2220		
Length (L1) in mm (")			5.8 ± 0.40 (0.228 ± 0.016)		
Width (W) in mm (")			$5.0 \pm 0.40 \ (0.197 \pm 0.016)$		
Thickness (T) in mm (")			4.5 Max (0.177 Max)		
Minimum Termination Band (L2,L3) in mm (")			0.25 (0.010)		
	n Band (L2,L3) in mm (")		1.00 (0.040)		
Minimum Band Gap (4.0 (0.158)		
Termination Material			FlexiCap [™] Polymer termination, Nickel barrier, Sn Plated Solder		
Solderability			(RoHS compliant) IEC-60068-2-58		
Packaging				7" Reel Horizontal Orientation, 500 per reel	
	G	eneral Electri	cal Specificati	on	
Rated Voltage			250Vac 50/60Hz, 5kV impulse		
Humidity Grade	Humidity Grade			Not applicable	
Maximum DC Working Voltage			-		
Nominal Capacitance Value			10nF		
Capacitance Tolerance			±10%		
Tangent of Loss Angle (Tan δ)			≤0.025		
Capacitance and Tan δ Test Conditions			1.0Vrms @ 1kHz		
Voltage Proof		100% test: 3000Vdc 1s min / 5s max AQL test: 3000Vdc / 2000Vac 60s min / 5kV 1.2x50µs impulse			
(50mA max charging current for DC tests)					
Min Insulation Resistance (IR)		100.00GOhm @ 100Vdc X7R (2R1) to AEC-Q200			
Dielectric Classification Rated Temperature Range		-55°C / +125°C			
		No DC Voltage ±15%			
Maximum Capacitance Change over Temperature Range			Rated DC Voltage		
Climatic Category (IEC)			55/125/56		
Ageing Characteristic			<2% per decade (nominal capacitance is 1000 hour value)		
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Part Number: 2220YA250103KETB16	Description: 2220 250Vac 50/60Hz 10nF ±10% X7R (2R1) to AEC-Q200					
Environmental						
RoHS Compliant to 2011/65/EC as amended by 2015/863/EU	Compliant					
REACH Compliant	224 compliant					
California Proposition 65	No exposure risk					
Board Layout						
	IDC 7251 ped decign					
Knowles' conventional 2-terminal chip capacitors can	IPC-7351 pad design					
generally be mounted using pad designs in accordance with international specification IPC-7351, Generic Requirements	C 5.30mm 0.209"					
for Surface Mount Design and Land Pattern Standards, but	C 5.30mm 0.209" Y 1.50mm 0.059"					
there are some other factors that have been shown to reduce	X 5.40mm 0.213"					
mechanical stress, such as reducing the pad width to less than the chip width. In addition, the position of the chip on the						
board should be considered.	Υ					
Some high voltage parts may require modifications to the						
board layout and/or the addition of a conformal coating to prevent flashover. Refer to application note AN0043 for						
further information.						
	t L					
Back	aging					
Facr						
Tape packaging information for tape-and-reel parts:	Product identifying label Plastic carrier tape					
Tape and reel packing of surface mounting chip						
capacitors for automatic placement are in accordance with IEC60286-3.	Тор					
Will IEC00200-3.	tape 8 or 12mm 178mm (7") or					
	Embossment nominal 330mm (13") dia. reel					
Solo	lering					
Reflow solder in accordance with IPC-A-610.	A					
Recommended reflow profile as laid down in	υ					
IPC/JEDEC J-STD-020.						
Ways caldering is also possible, but says must be						
Wave soldering is also possible, but care must be taken for case sizes 1210 and larger and component	Preheat					
Recommended reflow profile as laid down in IPC/JEDEC J-STD-020. Wave soldering is also possible, but care must be taken for case sizes 1210 and larger and component thickness >1.0mm. Trials are encouraged.						
Hand soldering is not recommended and can lead to						
component damage through thermal shock. Time						
Application notes with mounting and handling guidance are available on request.						
Compex DLI Johanson MFG	Novacap Syfer Voltronics					
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